

CC2538 Errata Note

EP/WCS/LPRF/ZigBeeloT

ABSTRACT

The **CC2538 System on Chip (SoC)** is described in the **CC2538 Data sheet** and the **CC2538 User guide**. This document describes issues that may be encountered when using the part according to the above mentioned documents. Where applicable, the relevant revisions of the SoC, the data sheet, or the user guide are specified.

Contents

1	Known Issues	2
1.1	ICEPICK system reset clears break points	2
1.1.1	Issue Description.....	2
1.1.2	Suggested Workarounds.....	2
1.2	GP timer edge mode (Prescaler)	3
1.2.1	Issue Description.....	3
1.2.2	Suggested Workarounds.....	3
1.3	Using emulator during power modes, EMUOVR behavior.....	4
1.3.1	Issue Description.....	4
1.3.2	Suggested Workarounds.....	4
1.5	Possible Incorrect Value of Clock Dividers after PM2 and PM3	5
1.5.1	Issue Description.....	5
1.5.2	Suggested Workarounds.....	5
1.6	USB controller can respond with NAK to other USB devices' packets, causing these devices to stop working	6
1.6.1	Issue Description.....	6
1.6.2	Suggested Workarounds.....	6
2	References.....	6

1 Known Issues

1.1 ICEPICK system reset clears break points

1.1.1 Issue Description

The ICEPICK system reset also (incorrectly) resets the following debugging modules in Cortex M3: FPB, DWT, ITM, TPIU.

This affects, amongst other things, the state of breakpoints and CPU debug mode. Programmed breakpoints are cleared, and the CPU will be in a free running mode after the ICEPICK system reset.

1.1.2 Suggested Workarounds

The following workaround is proposed for implementation in tools used for debugging of the device (for instance IAR Embedded Workbench, or Code Composer Studio).

For more information about which tools that integrates this workaround, and the specific implementation for each tool see SWRU345

The following are the steps to be performed by the debugger tool:

1. A system reset is triggered by the debugger (for example by user action, or as a reset strategy during connection or after a flash download)
2. Before doing the actual reset, read out all FPB, DWT, ITM, and TPIU registers.
3. Perform ICEPICK system reset, which will reset entire chip (including FPB, DWT, ITM, and TPIU units). The CM3 DAP is not reset, so connection with the debugger will not be lost.
4. Halt the CPU. It is recommended to implement a mechanism that avoids user code to be executed in the time elapsed between step 3 and 4, where the CPU is free running. This can for example be done with a conditional spin loop in the reset interrupt handler in software. If this method is used, the condition for the spin loop must be controllable from the debugger and changed at the end of the sequence to allow user code to be executed again.
5. Restore debug logic in CM3; FPB, DWT, ITM, and TPIU registers. (Note that FP_CTRL[1] is read-as-zero write-as-one, so simply writing back what you read from FP_CTRL will not re-enable the FPB unit)
6. Enable debug trap on core reset by writing DEMCR [0] = 1. This cause the CPU to halt at reset handler after the next core reset.
7. Perform a CPU reset (either from Icepick or NVIC registers).

1.2 GP timer edge mode (Prescaler)

1.2.1 Issue Description

When the GPTimer is configured in input time edge mode counting up with prescaler, the timer really becomes 24-bits wide since the prescaler acts as a timer extension. When the TAILR register is loaded with 0xFFFF and the prescaler value $\neq 0$, the captured time counts beyond the maximum allowed value. This results in the captured time possibly being larger than expected maximum value.

1.2.2 Suggested Workarounds

If the TAILR value is loaded with another value than 0xFFFF, the counter wraps correctly and the captured time is never larger than the maximum allowed value.

1.3 Using emulator during power modes, EMUOVR behavior

1.3.1 Issue Description

If an emulator is attached with the device in PM2, or PM3, the EMUOVR register state will be 0x00 after wakeup/restore instead of 0xFF as desired. If the device tries to enter PM1, PM2 or PM3 modes later when EMUOVR is 0x00, the emulator will lose connection.

1.3.2 Suggested Workarounds

If the emulator attaches to the CC2538 when in Sleep, PM0, PM1, PM2 or PM3 modes, the behavior of the EMUOVR register upon wakeup depends on the power mode state. If the emulator is attached with the device in Sleep, PM0, or PM1, the EMUOVR register state will be 0xFF upon wakeup as expected, assuming this was the state when the power mode was entered. If the emulator is attached with the device in PM2, or PM3, the EMUOVR register state will be 0x00. If the device tries to enter PM1, PM2 or PM3 modes later when EMUOVR is 0x00, the emulator will lose connection. To avoid losing the debugger connection on re-entering power modes, the EMUOVR register must be written to 0xFF by the debugger when it connects to the device. This workaround can be implemented in the debugger tools. For more information about which tools implements this workaround, and how it is implemented for each tool, see SWRU345.

1.5 Possible Incorrect Value of Clock Dividers after PM2 and PM3

1.5.1 Issue Description

The value of `SYS_CTRL_CLOCK_CTRL.SYS_DIV` is sampled by the system controller while the restore sequence is running, i.e. before the value of `SYS_DIV` is properly restored. If the value of `SYS_DIV` is 000b, the system controller will not resample the value of `SYS_DIV` once the register is properly restored. As a consequence, the system controller could end up using a random value for the system clock divider.

The same issue applies to `SYS_CTRL_CLOCK_CTRL.IO_DIV`.

1.5.2 Suggested Workarounds

If `SYS_DIV` and `IO_DIV` are different from 000b when entering PM2 or PM3, the system controller will always use the correct divider values from `SYS_DIV` and `IO_DIV` immediately after the restore sequence is done.

The suggested workaround is to write a non-zero value to `IO_DIV` and `SYS_DIV` immediately before entering the affected power modes and restore the correct value after waking up. One way of implementing the workaround is illustrated in the pseudo code below:

```
If (IO_DIV == 0) { reset_io_div_to_zero = true; IO_DIV = 1; }  
If (SYS_DIV == 0) { reset_sys_div_to_zero = true; SYS_DIV = 1; }  
wfi();  
if (reset_sys_div_to_zero == true) { SYS_DIV = 0; reset_sys_div_to_zero = false; }  
if (reset_sys_io_to_zero == true) { IO_DIV = 0; reset_io_div_to_zero = false; }
```

Note that the alternative setting is 1, which will give the same system clock rate as for a system running at 16 MHz. Also note that the system will use the internal 16 MHz high speed RC oscillator as clock source until the external 32 MHz clock source is active and stable after waking up from PM2 or PM3. As a consequence, the `SYS_DIV` and `IO_DIV` setting of 1 will not affect the timing of the system as long as they are set back to 0 before the 32 MHz external clock source is stable.

1.6 USB controller can respond with NAK to other USB devices' packets, causing these devices to stop working

1.6.1 Issue Description

The CC2538 USB controller will sometimes interrupt communication between other USB devices on the bus by responding with NAK to packets not destined for itself.

The bug can be triggered if the USB host interleaves the following:

- IN transactions (from device to host) of the data stage of a CC2538 endpoint 0 control transfer.
- Any full-speed transaction containing a DATA1 packet to another USB device.

More specifically, the bug occurs if a DATA1 packet (to another USB device) is received by CC2538 before it has loaded the next IN data packet.

1.6.2 Suggested Workarounds

This problem is rare, and will only occur when the CC2538 shares a USB root hub with other USB devices. It has only been observed when using USB 3.0 host controllers, and only when the other USB device uses outgoing data transfers actively (e.g. file transfer by a Bluetooth USB dongle).

There are two workarounds that will reduce, but not eliminate, the occurrence of this issue:

- Avoid using endpoint 0 control transfers to operate the CC2538 USB device.
- Load the IN data packets for control transfers as quickly as possible.

2 References

1. CC2538 Data sheet ([SWRS096](#))
2. CC2538 IDE User's guide ([SWRU345](#))

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